EDITOR'S NOTES

In this issue, we introduce two new features: a digest of the most recent Group Administrative Committee (AdCom) meeting, and the first three of a planned series of AdCom member biographies. Because this issue also contains a Group membership roster, some regular features have been displaced temporarily.
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Newsletter policy with respect to short-course announcements, as established by the AdCom, is to provide publication for information only. No endorsement is implied, and no check on course content or instructor qualifications has been accomplished.

**University of Arizona**

Systems Engineering Institute: October 28-November 1. Five days, $270 (includes course material, lunches, banquet, parking/campus transportation). Write: Director of Conferences and Institutes, Division of Continuing Education, the University of Arizona, Tucson, Arizona 85721.

**University of Wisconsin**

Standards Engineering Institute: October 31-November 1. Two days, $170. Write: Institute Director, 723 Extension Building, The University of Wisconsin, 412 North Lake Street, Madison, Wisconsin 53706.

Information Retrieval Workshop: November 11-12. Two days, $70. Write: as above.

Available from the Order Department, IEEE, 345 East 47th Street, New York, N.Y. 10017. "Sixth Annual Reliability Physics Symposium Proceedings" ($6.00 to IEEE members, $11.00 nonmembers). Includes 38 papers, 6 of which were "flash papers" of recent results written a few days before the symposium.

Available from Miss Helen Yean, IEEE Office, Moore School of Electrical Engineering, University of Pennsylvania, Philadelphia, Pa. 19104. Proceedings of the first all-day seminar on failure analysis, Philadelphia Chapter, G-R ($5.00). Includes the eight papers identified under Chapter News.

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**Meet your AdCom...**

Ed Jahr, Chairman of the Administrative Committee, is a Staff Engineer in Quality Engineering Systems and Data Control at the IBM Electronics Systems Center. He received his BS from Wartburg College, with honors in Physics, and engaged in graduate studies in Education at the University of Colorado and Physics and Electrical Engineering at the University of Kansas.

During World War II, Ed completed radar courses at Princeton and MIT and served as a U.S. Navy Radar/Radiation Officer at Guantanamo and in the Philippine Islands.

He was formerly a high school principal and has been an instructor in Physics, Mathematics, Radar Theory, and research problems in a technical institute, a Signal Corps training school, and a university. Ed also has had experience as a designer and builder of electronics research instruments, and for nine years was engaged in work on various reliability programs with ARINC Research Corporation.

Ed is the author of several papers and reports on reliability problems and has been a member of the Management Committee of the Annual Reliability Symposium for the past ten years, having served as General Chairman in 1984. He is a past chairman of the Binghamton Chapter, a Senior Member of IEEE and a member of Sigma XI.
Len Schneider has been Secretary of the Administrative Committee for the past six years and was, until this summer, Editor of the Newsletter. His service to the Group at the national level began twelve years ago with participation in the original IIEC-ASQC Reliability Training Text, and as a consultant instructor in the first course.

Len is Manager of Minuteman Reliability and Quality Assurance at TRW Systems. He previously held positions as a partner in Reliability Engineering Associates and as project director for the Cook Electric Company. He is a registered professional engineer (Illinois).

Len lives with his wife, Fritz, and each of his three children as are not away at college at the moment, in Palos Verdes, California.

Marion Smith, Past Chairman 1964-66, continues to serve as a busy member of the Administrative Committee and is Director of Product Assurance, Honeywell Aerospace Florida Division. He is also a member of the Reliability Committee for the U.S. National Committee to the International Electrotechnical Commission and serves as Honeywell's corporate representative on the AIA Reliability Committee. To round out his schedule, he also serves on the U.S. Air Force Scientific Advisory Board Reliability Committee.

Marion has been Chairman of the Board and General Chairman for the Annual National Symposium on Reliability, Chairman of the Florida West Coast Section of the IRE, and has authored papers on inertial navigation systems, reliability engineering and analysis.

He graduated from Louisiana State University with a BSEE in 1948 and did other undergraduate work at Oklahoma AAM and at Yale University. Marion is continuing his education in Engineering Administration at the University of South Florida. He has three children and lives with his wife, Pat, (who also attended LSU) in Clearwater.

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MEETING DIGEST

The G-R Administrative Committee met August 28 at Los Angeles. Attending the meeting were Ed Jabe, Len Schneider, Bill Sumerlin, Abe Okun, Paul Gottfried, George Beyer, Jim King, Marion Smith, and John Comer. Leon Podolsky, IEEE Consultant, also sat in on part of the meeting.

The business of the meeting included several items of general interest to the G-R membership, such as:

- G-R participation in standards activity, concerning Safety as well as Reliability. Joe Novex of BADD serves as the G-R interface with the IEEE Standards Committee.
- G-R interests in CADAR activities, for which a strong link is provided through Clint Purdue in his dual capacities in CADAR and as CARAD Chairman within G-R. (The G-R membership is reminded that free subscription to the CADAR Newsletter is theirs for the asking, upon request to Dick Emberman at IEEE Headquarters.)
- The next G-R sponsored national meeting, the Reliability Physics Symposium to be held at the Washington Hilton December 2-4. This will be followed by the National Symposium on Reliability January 21-23 at the Palmer House in Chicago.
- Plans for obtaining a second-class mailing permit for the Reliability Newsletter, which will result in reduced postage costs and possible improvement in delivery.

Prospects for the publication of the next issue of the "Speaker Who's Who in Reliability", a joint effort of G-R, the ASQC Electronics Division, and the ASQC Reliability Division, in July 1968. The most recent issue (#4, February 1968), produced under the chairmanship of Bob Williams, has been so successful that Bob was asked to make a presentation concerning it to the August 28 IEEE Chapter Forum. (The list, automatically distributed to local and national IEEE and ASQC officers, is available for use in connection with official activities of these societies and affiliated groups.)

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call for

NOMINATIONS

Annually six of the eight members of the Administrative Committee of the IEEE Reliability Group are nominated and elected. The Nominating Committee of the AdCom is assembling recommendations for nominees. Your recommendations for Administrative Committee members are hereby solicited in accordance with paragraph 6.1 of the Group Bylaws which are reproduced below. Nominations to fill AdCom vacancies will be carried out in accordance with the paragraph 6.2 which is also quoted below.

Send your recommendations for nominees to: M. P. Smith, Honeywell, Inc., 13350 U.S. Highway 19 N., St. Petersburg, Florida 33715.

Excerpt from IEEE Group Bylaws

6.1 - A slate of nominees for members-at-large vacancies of the AdCom shall be prepared by the Nominating Committee. Recommendations for such nominees shall be solicited by a letter to the chairmen of all subgroups and standing committees. In addition, the chairmen of the Nominating Committee shall cause to be published and distributed to the entire Group membership a call for nominations; a nominating petition carrying a minimum of 25 names of Group members, excluding students, shall automatically place that nominee on the slate to be presented to the AdCom.

6.2 The election to fill forthcoming vacancies of the AdCom membership at-large shall be by mail ballot to the hold-over members of AdCom. The deadline for the return of ballots shall be not less than 30 calendar days after the actual date of mailing of the ballots. Election shall be based on the highest number of votes, taken in descending order until all vacancies are filled. Ties shall be broken by the AdCom. The Chairman of the Nominating Committee shall submit the names of such elected members to the Chairman of the Groups Committee and through him to the IEEE Executive Committee.

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ACTION ITEM: all g-r members

This issue of the Newsletter, containing a complete listing of our fellow members of the Reliability Group, calls to our attention the need for all of us to get busy and build up its strength and effectiveness.

Each of you, no doubt, will find names of your co-workers in Reliability or Maintainability, or at least some of your acquaintances, conspicuous by their absence. May I urge each of you individually to examine the list critically and further in person to invite and urge those not listed to join with us in our efforts to strengthen the profession. We all benefit by joint action and exchange of ideas through this united Group called Reliability but including a strong and increasing emphasis on Maintainability.

Persons joining the Group and/or IEEE between October 1 and December 31 pay for the year 1969 and receive a bosom of full benefits, including publications, during the remainder of 1968. You can also tell them of the many tangible advantages of membership, such as receiving -- at no extra charge -- the Newsletter, Transactions, and the Proceedings of the National Reliability Symposium.

A coupon is provided herewith. Please pass it along to a prospect.

Bob Williams
Membership Chairman

Mr. Robert L. Williams
Westinghouse Aerospace
P. O. Box 745
Baltimore, Maryland 21203

Please send application blanks and descriptive literature to:

☐ IEEE Member, interested in joining G-R
☐ Nonmember, interested in joining IEEE and G-R
☐ Nonmember, interested in affiliating with G-R.